



Regional Summit

2008  NAFEMS

2020 Vision of Engineering Analysis and Simulation

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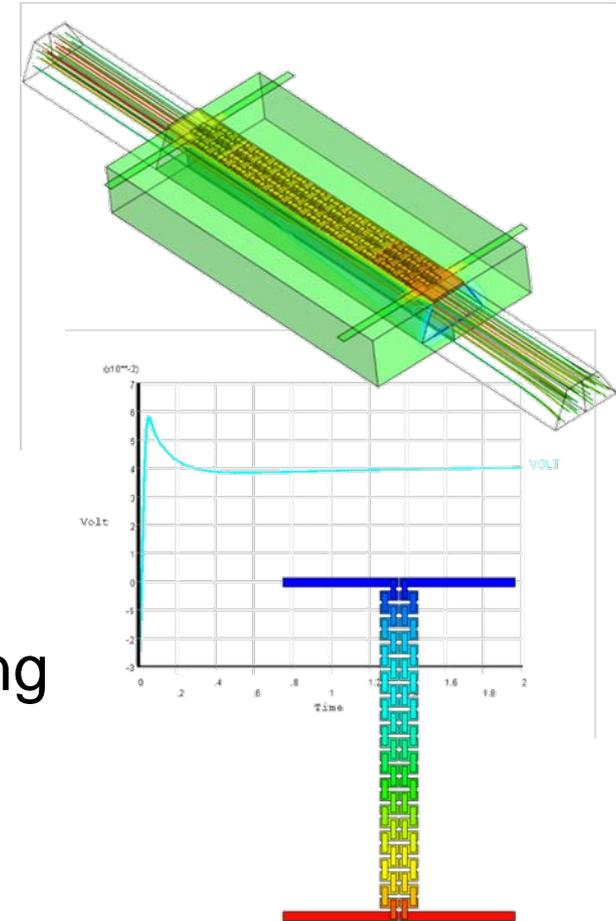
Multiphysics Simulation using Direct Coupled-Field Element Technology

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Agenda

- Multiphysics Overview
- Direct Coupled-Field Elements
- Applications
 - Piezoelectricity
 - Thermal-Electric Coupling
 - Electroelasticity
 - Structural-Thermal-Electric Coupling
- Conclusions
- Questions and Answers

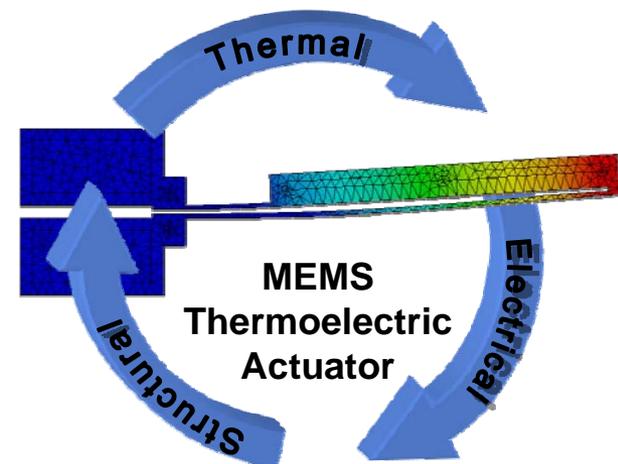


Thermoelectric Generator

Multiphysics - Why Consider It?

- You can't afford to ignore coupled physics when:
 - The real world is a multiphysics world
 - Your design depends on coupled physical phenomena
 - You are faced with small error margins
 - Physical testing is too costly

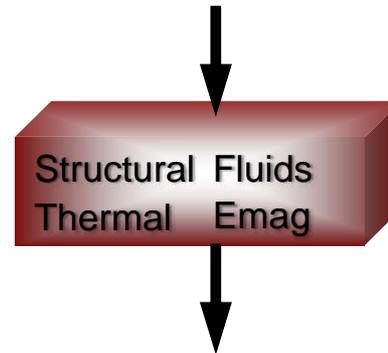
Innovative companies are moving beyond single physics analysis



Methods of Coupling Physics

- Direct Coupling

- A single analysis employing a coupled-field element containing all the necessary DOFs to solve the coupled-field problem.

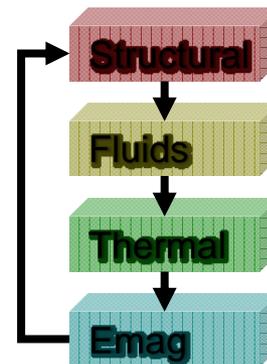


Direct Coupling

- Element-level coupling
- Highly coupled physics
- Single model & mesh

- Load Transfer

- Two or more analysis are coupled by applying results from one analysis as loads in another analysis.

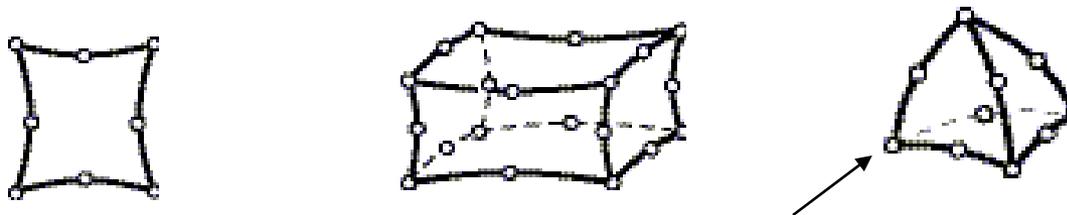


Load Transfer

- Sequential solution
- Separate model & mesh
- Separation of expertise

Direct Coupled-Field Element

- A finite element that couples the effects of interrelated physics within the element matrices or load vectors, which contain all necessary terms required for the coupled physics solution.
- Strong (matrix) or weak (sequential) coupling
- Many industry applications



DOF: UX, UY, UZ, TEMP, VOLT, (AZ)



Strong (Matrix) Coupling

- Finite element matrix equation:

$$\begin{bmatrix} [\mathbf{K}_{11}] & [\mathbf{K}_{12}] \\ [\mathbf{K}_{21}] & [\mathbf{K}_{22}] \end{bmatrix} \begin{Bmatrix} \{\mathbf{X}_1\} \\ \{\mathbf{X}_2\} \end{Bmatrix} = \begin{Bmatrix} \{\mathbf{F}_1\} \\ \{\mathbf{F}_2\} \end{Bmatrix}$$

- The coupling is accounted for by the off-diagonal matrices $[\mathbf{K}_{12}]$ and $[\mathbf{K}_{21}]$.
- Provides for a coupled solution in one iteration for linear problems
- Examples: Piezoelectricity, Seebeck effect, thermoelasticity

Weak (Sequential) Coupling

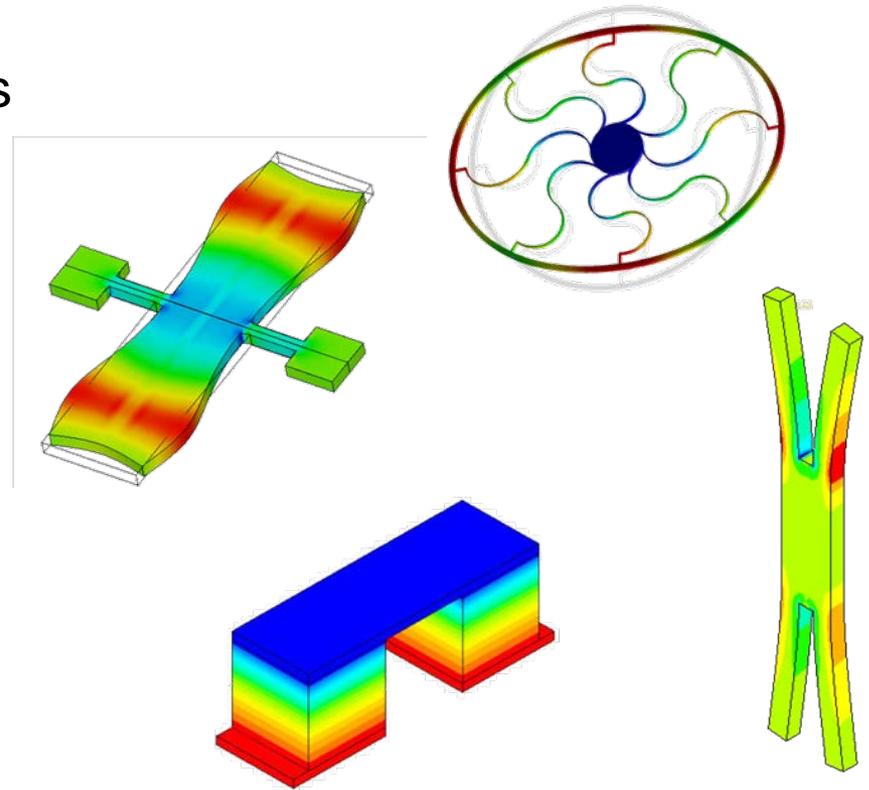
- Finite element matrix equation:

$$\begin{bmatrix} [K_{11}(\{X_1\}, \{X_2\})] & [0] \\ [0] & [K_{22}(\{X_1\}, \{X_2\})] \end{bmatrix} \begin{Bmatrix} \{X_1\} \\ \{X_2\} \end{Bmatrix} = \begin{Bmatrix} \{F_1(\{X_1\}, \{X_2\})\} \\ \{F_2(\{X_1\}, \{X_2\})\} \end{Bmatrix}$$

- The coupled effect is accounted for in the dependency of $[K_{11}]$ and $\{F_1\}$ on $\{X_2\}$ as well as $[K_{22}]$ and $\{F_2\}$ on $\{X_1\}$.
- At least two iterations are required to achieve a coupled response.
- Examples: Joule heating, electric forces, piezoresistivity

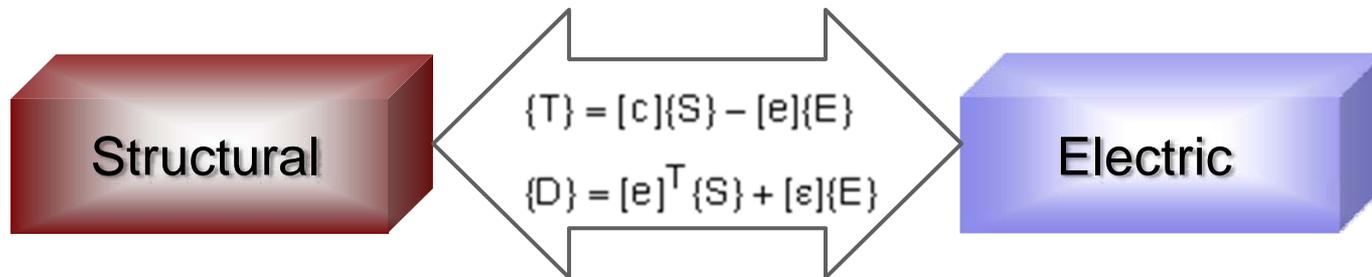
Applications for Coupled-Field Elements

- Piezoelectric
 - Transducers, resonators, sensors and actuators, vibration control
- Piezoresistive
 - Pressure sensors, strain gauges
- Thermal-electric
 - Wires, busbars, Peltier coolers
- Thermoelastic damping
 - MEMS resonators
- Electroelastic
 - Actuators, artificial muscle
- Coriolis Effect
 - Quartz angular velocity sensors



Piezoelectric Analysis

- In a piezoelectric analysis, the structural and electrostatic fields are coupled by the piezoelectric constants $[e]$:



$\{T\}$ - stress vector

$\{S\}$ - elastic strain vector

$[c]$ - elastic stiffness

$[e]$ - piezoelectric matrix

$\{D\}$ - electric flux density

$\{E\}$ - electric field intensity

$[\varepsilon]$ - dielectric permittivity

Piezoelectric Finite Element Equations

- Strong (Matrix) Coupling

$$\begin{bmatrix} \mathbf{K}_{UU} & \mathbf{K}_{UV} \\ \mathbf{K}_{UV}^T & -\mathbf{K}_{VV} \end{bmatrix} \begin{Bmatrix} \mathbf{U} \\ \mathbf{V} \end{Bmatrix} + \begin{bmatrix} \mathbf{C}_{UU} & 0 \\ 0 & -\mathbf{C}_{VV} \end{bmatrix} \begin{Bmatrix} \dot{\mathbf{U}} \\ \dot{\mathbf{V}} \end{Bmatrix} + \begin{bmatrix} \mathbf{M}_{UU} & 0 \\ 0 & 0 \end{bmatrix} \begin{Bmatrix} \ddot{\mathbf{U}} \\ \ddot{\mathbf{V}} \end{Bmatrix} = \begin{Bmatrix} \mathbf{F} \\ \mathbf{Q} \end{Bmatrix}$$

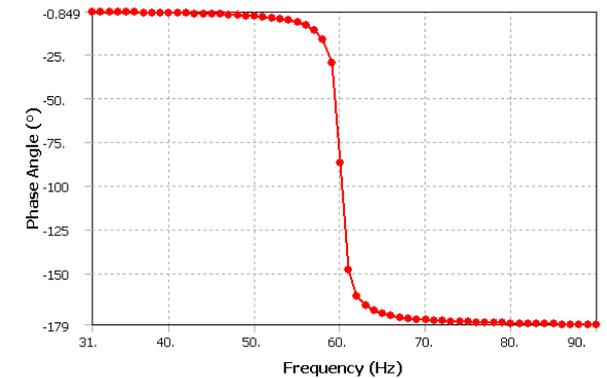
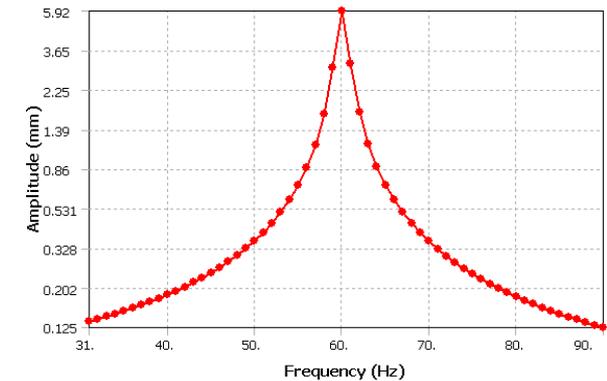
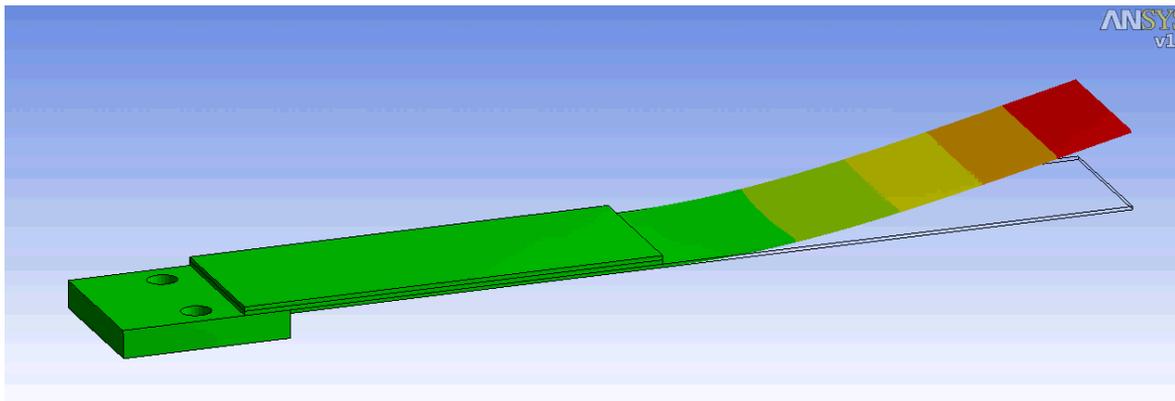
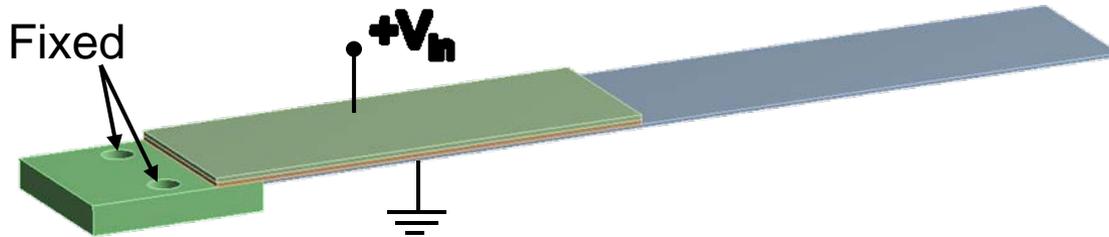
- U and V are strongly coupled piezoelectric matrices $[\mathbf{K}_{UV}]$ and $[\mathbf{K}_{UV}]^T$
- Symmetric Matrices
- Static, Harmonic, Transient

Element matrices:

\mathbf{K}_{UU} - structural stiffness
 \mathbf{K}_{VV} - dielectric permittivity
 \mathbf{K}_{UV} - piezoelectric coupling
 \mathbf{C}_{UU} - structural damping
 \mathbf{C}_{VV} - dielectric dissipation
 \mathbf{M}_{UU} - mass

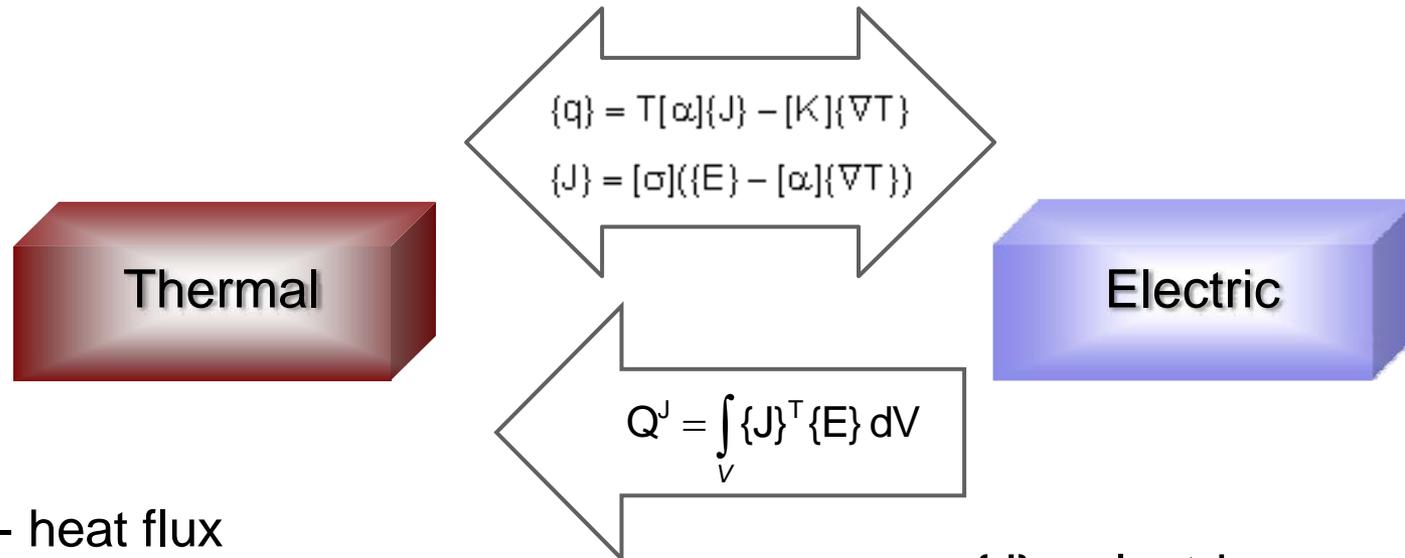
Piezoelectric Fan Example

- Results
 - Fan driven at resonance
 - 120 Volts at 60 Hz



Thermal-Electric Analysis

- In a thermoelectric analysis, the thermal and electric fields are coupled by the Joule heat Q^J and Seebeck coefficients $[\alpha]$:



$\{q\}$ - heat flux

T - temperature (absolute)

$[K]$ - thermal conductivity

$[\alpha]$ - Seebeck coefficients

$\{J\}$ - electric current density

$\{E\}$ - electric field intensity

$[\sigma]$ - electrical conductivity

Thermal-Electric Finite Element Equation

- Matrix and/or Load Vector Coupling

$$\begin{bmatrix} K_{TT} & 0 \\ K_{VT} & K_{VV} \end{bmatrix} \begin{Bmatrix} T \\ V \end{Bmatrix} + \begin{bmatrix} C_{TT} & 0 \\ 0 & C_{VV} \end{bmatrix} \begin{Bmatrix} \dot{T} \\ \dot{V} \end{Bmatrix} = \begin{Bmatrix} Q + Q^P + Q^J \\ I \end{Bmatrix}$$

- T and V Coupling

– Matrix

- Seebeck K_{VT}

– Load Vector

- Joule Q^J Load Vector
- Peltier Q^P Load Vector

- Symmetric - Joule Heating

- Unsymmetric - Seebeck

Element matrices:

K_{TT} - thermal conductivity

K_{VV} - electric conductivity

K_{VT} - Seebeck coupling

C_{TT} - specific heat damping

C_{VV} - dielectric damping

Thermoelectric Cooler Example

- Thermoelectric Cooler
 - Thermal-electric coupling
 - n-type and p-type semiconductors

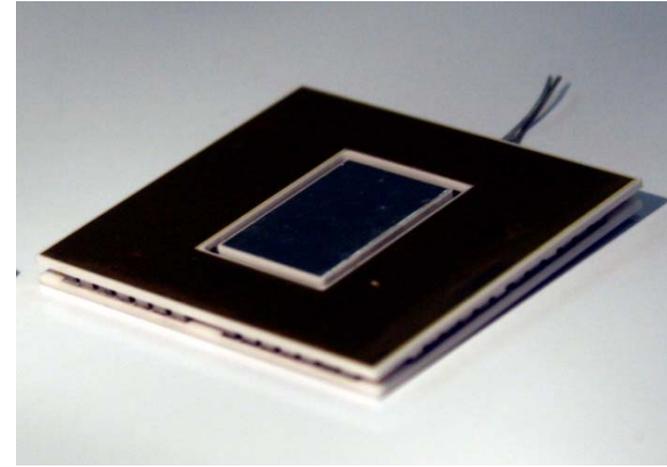
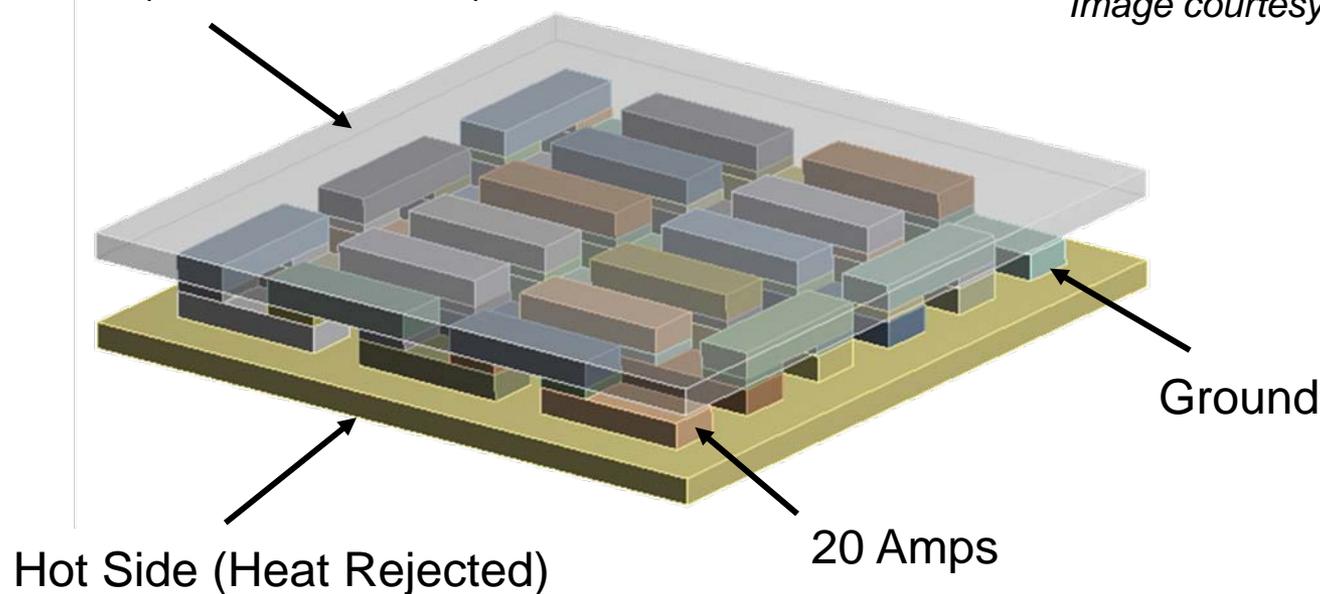


Image courtesy of Marlow Industries

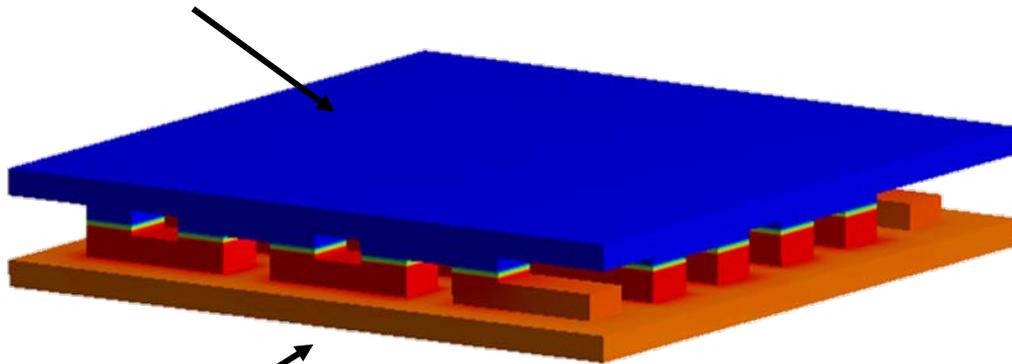
Cold Side (Heat Absorbed)



Thermoelectric Cooler Example

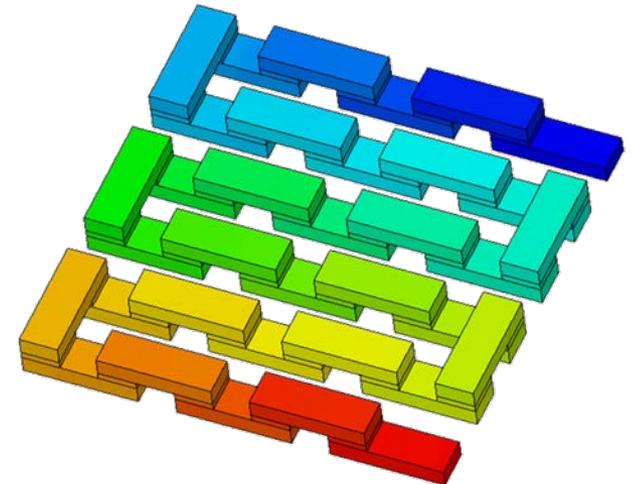
- Thermoelectric Results
 - Thermal gradient in Peltier blocks

Cold Side (Heat Absorbed)

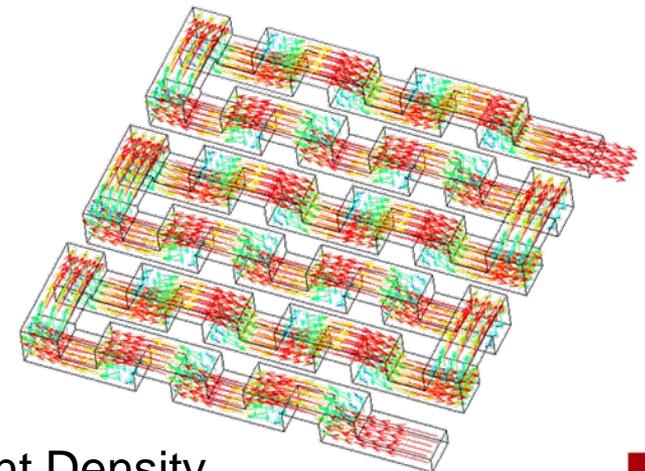


Temperature

Hot Side (Heat Rejected)



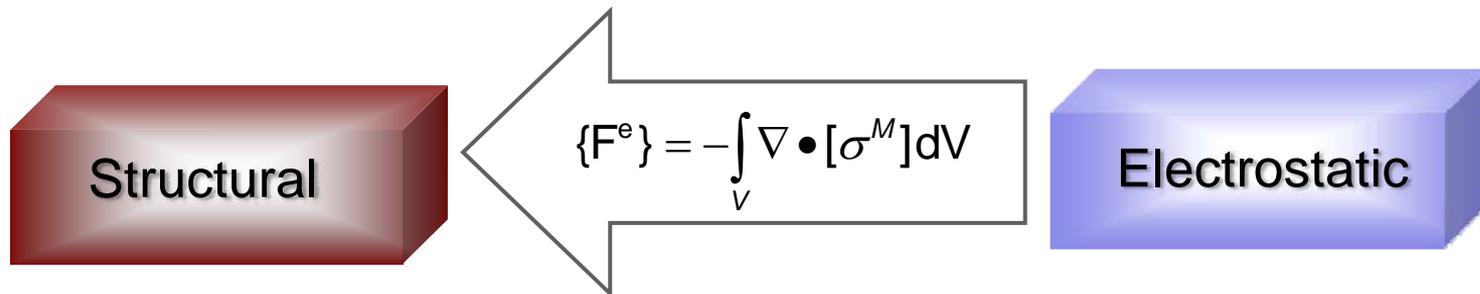
Electric Potential



Current Density

Electroelastic Analysis

- In an electroelastic analysis, structural and electrostatic fields are coupled by an electric force $\{F^e\}$:



$$[\sigma^M] - \text{Maxwell stress tensor} = \frac{1}{2} (\{E\}\{D\}^T + \{D\}\{E\}^T - \{D\}^T \{E\}\{I\})$$

$\{D\}$ - electric flux density

$\{E\}$ - electric field intensity

$\{I\}$ - identity matrix

Electroelastic Finite Element Formulation

- Load Vector (Weak) Coupling

$$\begin{bmatrix} K_{UU} & 0 \\ 0 & K_{VV} \end{bmatrix} \begin{Bmatrix} U \\ V \end{Bmatrix} + \begin{bmatrix} C_{UU} & 0 \\ 0 & C_{VV} \end{bmatrix} \begin{Bmatrix} \dot{U} \\ \dot{V} \end{Bmatrix} + \begin{bmatrix} M_{UU} & 0 \\ 0 & 0 \end{bmatrix} \begin{Bmatrix} \ddot{U} \\ \ddot{V} \end{Bmatrix} = \begin{Bmatrix} F + F^e \\ Q \end{Bmatrix}$$

- U and V are couple through the electric force load vector $\{F^e\}$
- Iterative Solution
- Symmetric Matrix

Element matrices:

K_{UU} - structural stiffness

K_{VV} - dielectric permittivity

C_{UU} - structural damping

C_{VV} - dielectric dissipation

M_{UU} - mass

Folded Dielectric Elastomer Actuator

- Linear Actuator
 - Applied voltage between the compliant electrodes
 - Compresses based on electrostatic pressure

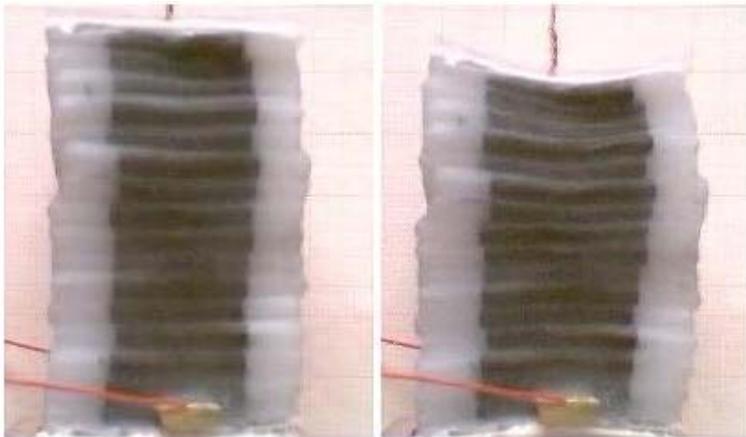
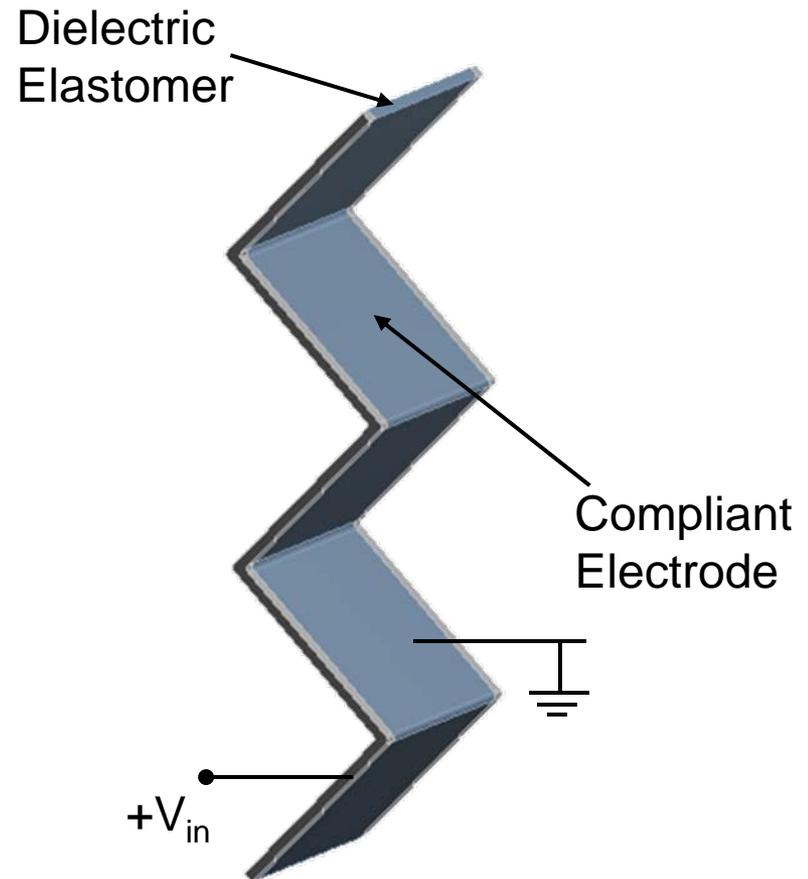


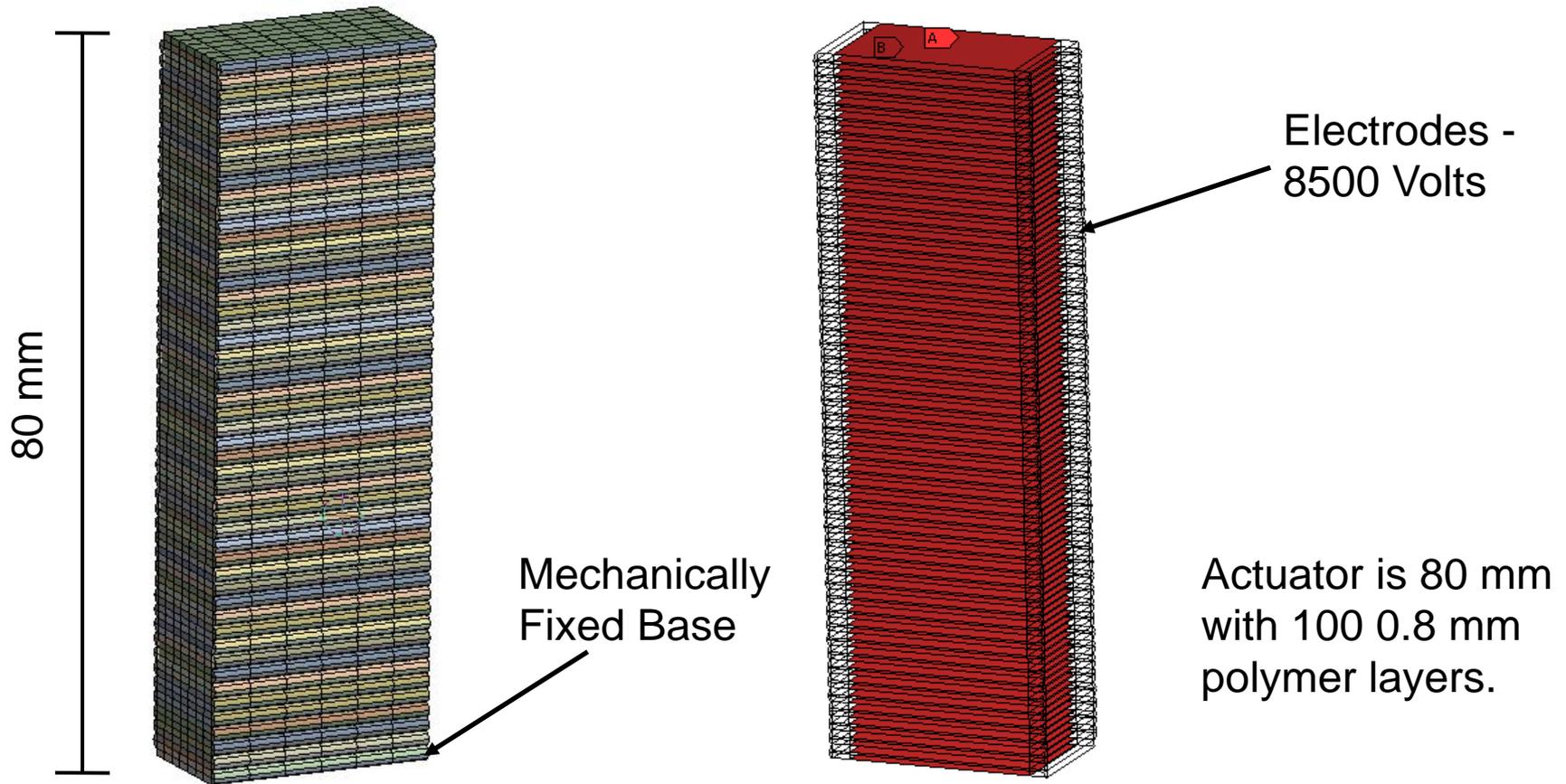
Image courtesy of Federico Carpi, University of Pisa



Folded Sheet of Dielectric Elastomer

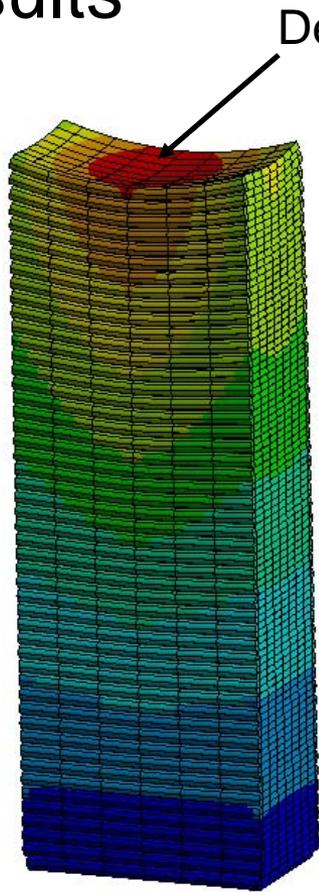
Folded Dielectric Elastomer Actuator

- Finite Element Model



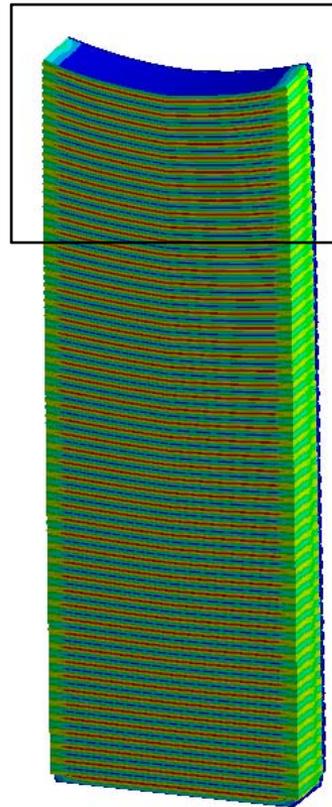
Folded Dielectric Elastomer Actuator

- Results

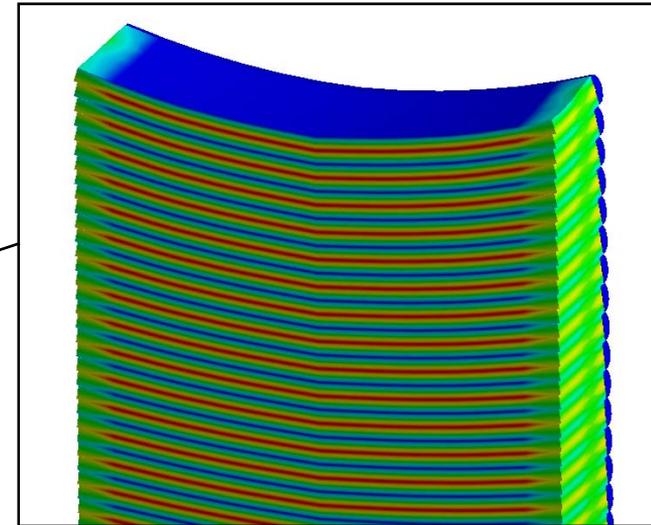


Deformation

Deflection = 7.15 mm



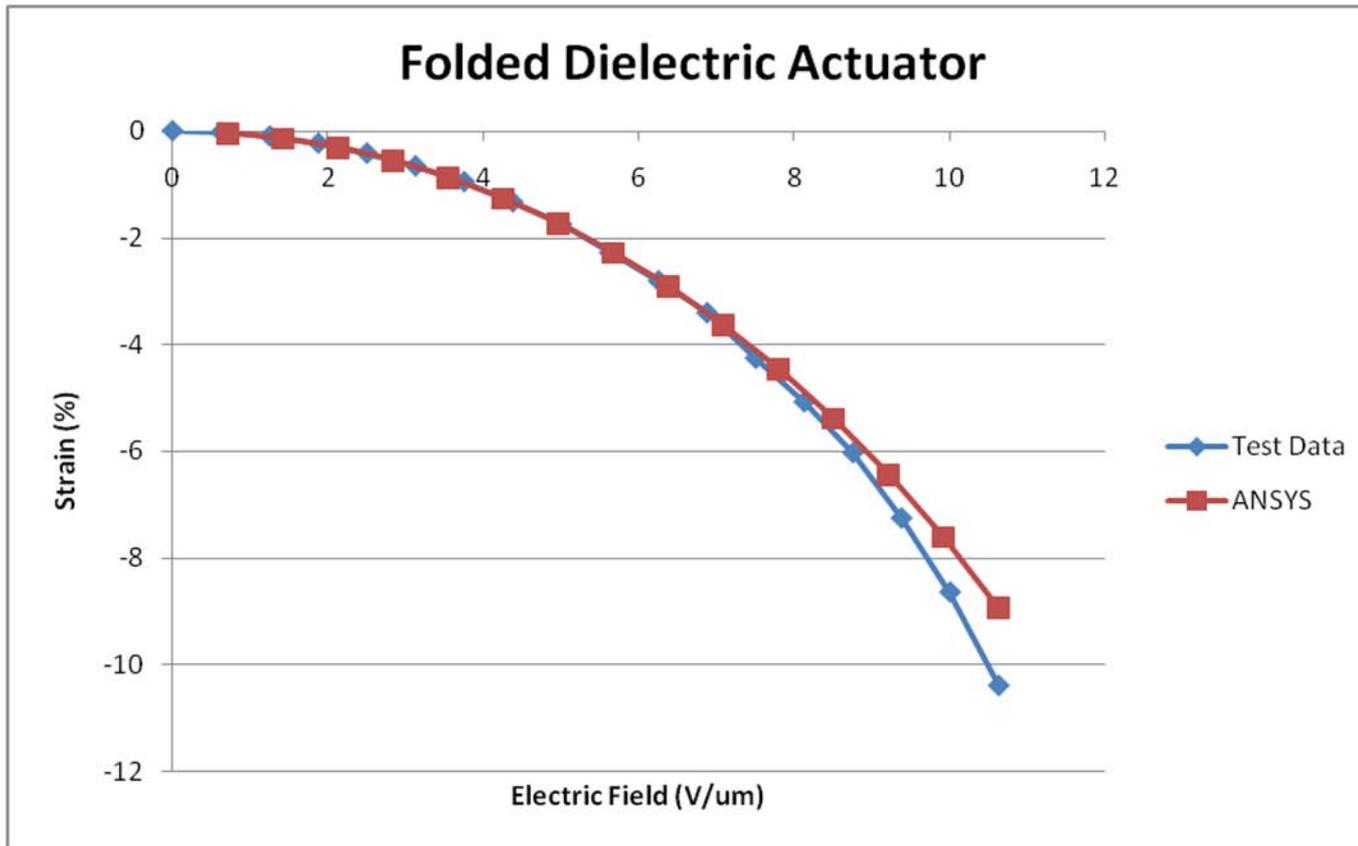
Electric Potential



Electric Potential =
8500 Volts

Folded Dielectric Elastomer Actuator

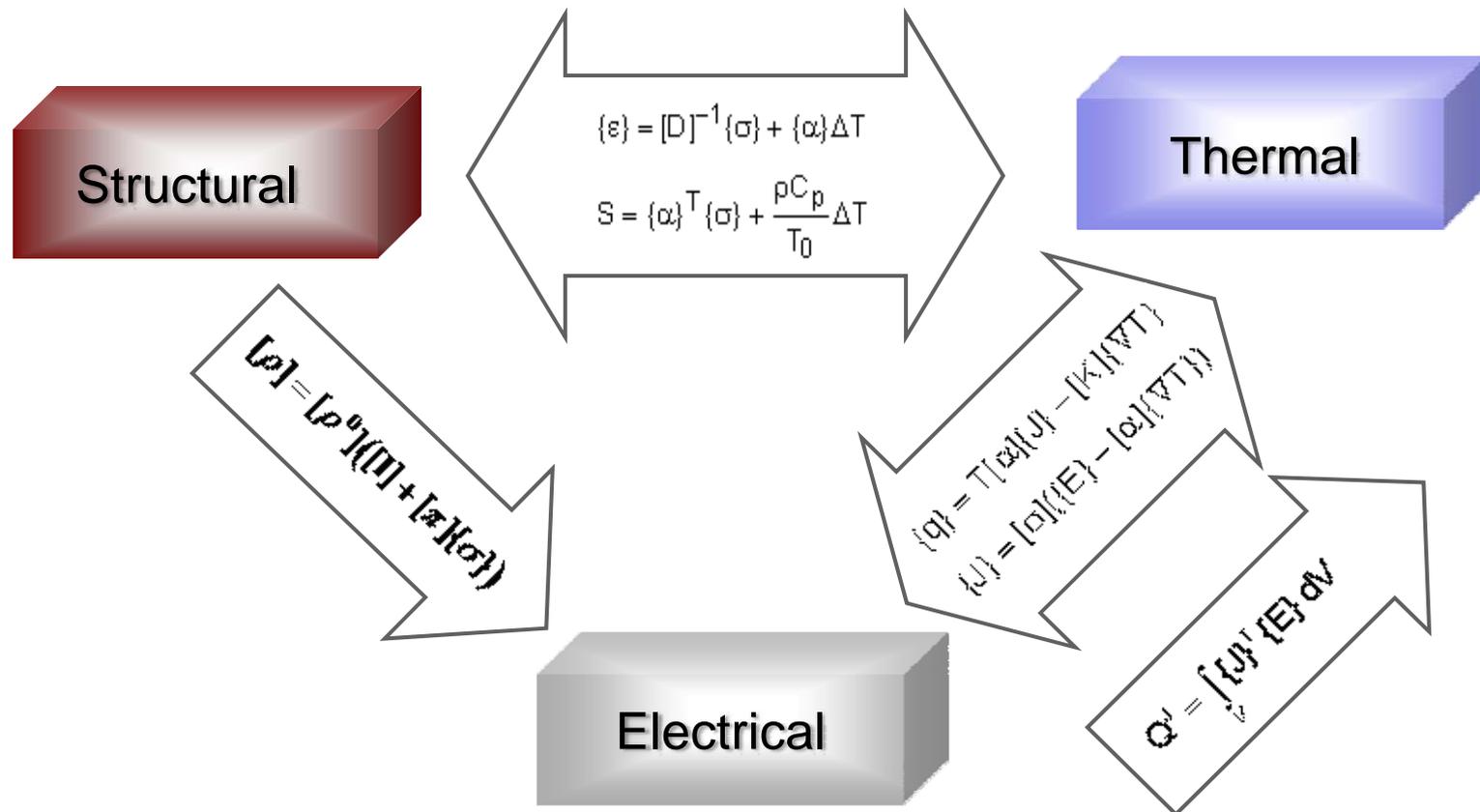
- Comparison with Test Data



Excellent correlation to the test data to about 7% strain. Model is stiffer than actual device between 7% and 10% strain.

Structural-Thermal-Electric Coupling

- A structural-thermal-electric analysis including thermal expansion, piezocaloric, Joule heating, Seebeck/Peltier and piezoresistive effects:



Finite Element Formulation

- Matrix/Load Vector Coupling

$$\begin{bmatrix} K_{UU} & K_{UT} & 0 \\ 0 & K_{TT} & 0 \\ 0 & K_{VT} & K_{VV}(U) \end{bmatrix} \begin{Bmatrix} U \\ T \\ V \end{Bmatrix} + \begin{bmatrix} C_{UU} & 0 & 0 \\ -T_0 K_{UT}^T & C_{TT} & 0 \\ 0 & 0 & C_{VV} \end{bmatrix} \begin{Bmatrix} \dot{U} \\ \dot{T} \\ \dot{V} \end{Bmatrix} + \begin{bmatrix} M_{UU} & 0 & 0 \\ 0 & 0 & 0 \\ 0 & 0 & 0 \end{bmatrix} \begin{Bmatrix} \ddot{U} \\ \ddot{T} \\ \ddot{V} \end{Bmatrix} = \begin{Bmatrix} F \\ Q+Q^J+Q^P \\ I \end{Bmatrix}$$

- U and T are strongly coupled by thermoelastic coupling matrices K_{UT} and C_{TU}
- T and V are strongly coupled by Seebeck coefficient matrix K_{VT} and weakly coupled by Peltier and Joule load vectors Q^J Q^P
- U and V are weakly coupled by the piezoresistive coefficients $K_{VV}(U)$
- Unsymmetric Matrix

Element matrices:

K_{UU} - structural stiffness

K_{TT} - thermal conductivity

K_{UT} - thermoelastic coupling

K_{VV} - electric conductivity

K_{VT} - Seebeck coupling

C_{UU} - structural damping

C_{TT} - specific heat damping

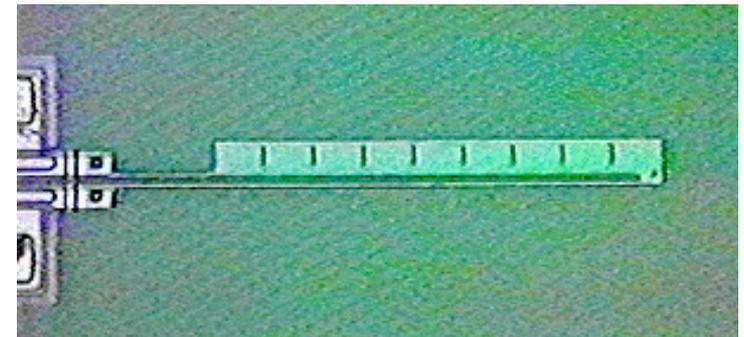
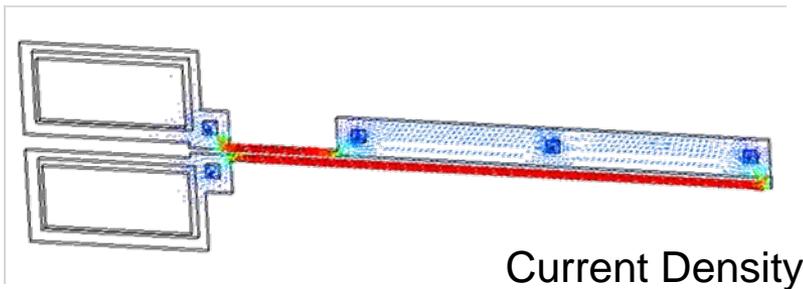
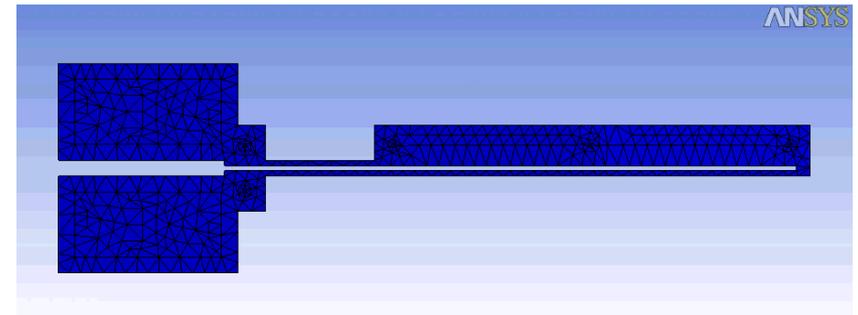
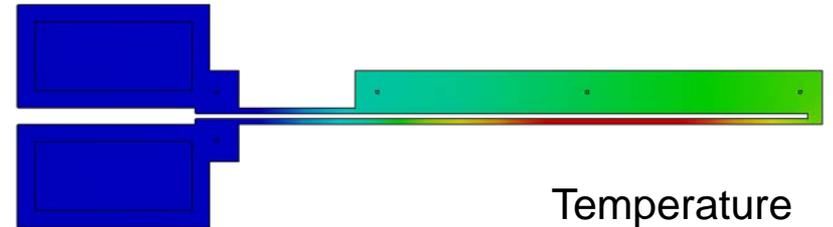
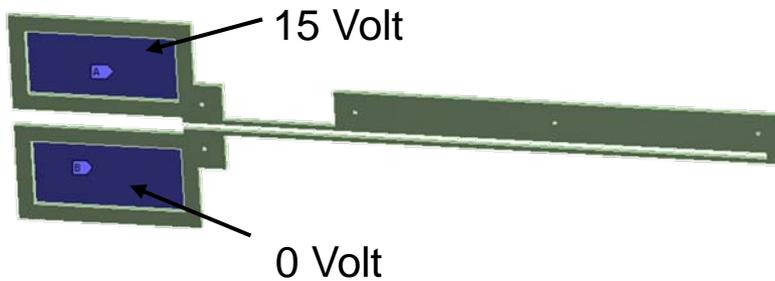
C_{VV} - dielectric damping

M_{UU} - mass

T_0 - absolute reference temperature

Thermal-Electric Actuator Example

- Thermal-Electric Actuator



SEM image courtesy of Victor Bright, University of Colorado at Boulder

Deflection is induced by the differential thermal expansion between the thin and wide arms.

Conclusions

- Direct Coupled Field Elements

- Advantages

- Ease of use

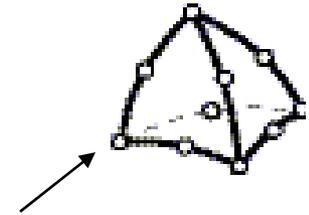
- One element type
- One finite element model
- One set of results

- Robust for nonlinear coupled-field solutions

- Nonlinear geometric effects

- Disadvantages

- Large model sizes
- Can create unsymmetric matrices



DOF: UX, UY, UZ, TEMP,
VOLT, (AZ)

